

SPECIFICATION

Part No. : **AP.10G.01**

Product Name: 10mm SMT 14dB Active GPS/GALILEO Patch Antenna

With Front End Saw Filter

Features : Unique SMT GPS/GALILEO active patch

Wide Input Voltage 1.5V to 3.3V

Ultra low power consumption

RoHS Compliant





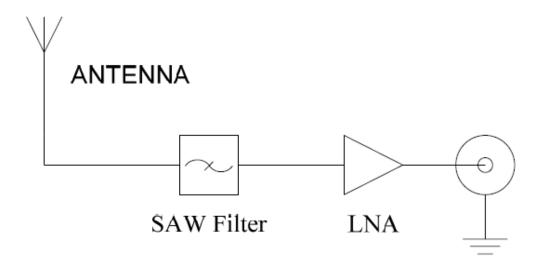


1. Introduction

The AP.10G.01 one stage 14dB active GPS/GALILEO patch antenna is the smallest SMT GPS/GALILEO high performance embedded antenna currently available in the world. Using extremely sensitive high dielectric constant powder formulation and tight process control the 10mm x 10mm x 4mm patch antenna is accurately tuned to have its frequency band right at 1575.42MHz for GPS/GALILEO systems.

A patented SMT structure gives high reliability in integration. With an ultra low power consumption one stage LNA with Saw Filter, this small active patch has the performance of an ordinary active patch, but at only a quarter of the size. This product is suited to small form factor mobile devices such as GPS Smartphones, Personal Location, Medical devices, Telematic devices and Automotive navigation and tracking. Custom gain, connector and cable versions are available.

The AP.10G consists of 2 functional blocks – the LNA and also the patch antenna.





2. Specification

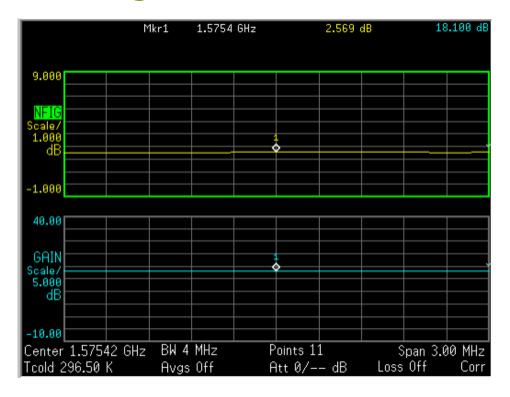
ANTENNA							
Frequency	1575.42 ± 1.023MHz						
Gain (Patch)	Typ -10dBic @ Zenith						
Gain (Patch and LNA)	8 ± 4dBic @ 90°						
Impedance	50Ω						
Polarization	RHCP						
Axial Ratio	Max 4.0dB @ Zenith						
Input Voltage	Min. 1.5V, Typ. 1.8V, Max. 3.3V						
LNA							
Frequency	1575.42 ± 1.023MHz						
	F0=1575.42MHz						
Outer Band Attenuation	F0±30MHz 9dB min.						
Gater Barra Accernation	F0±50MHz 14dB min.						
	F0±100MHz 16dB min.						
Output Impedance	50Ω						
Output VSWR	2.0 Max						
Pout at 1dB Gain Compression point	Typ. 1dBm						
LNA	LNA Gain, Power Consumption and Noise Figure						
Voltage	LNA Gain (Typ)	Power Consumption(mA) Typ	Noise Figure Typ			
Min. 1.5V	18dB	3.5mA		2.6dB			
Typ. 1.8V	18dB	3.5mA		2.6dB			
Max. 3.3V	18dB	3.5mA		2.6dB			
	MECHANICAL						
Dimension		10mm x 10mm x 4mm (add 7.3mm depth for vertical PCB)					
Connection			SMT via solder pads				
ENVIRONMENTAL							
Operation Temperature		-20	-20°C to + 85°C				
Storage Temperature		-30	-30°C to + 85°C				
Relative Humidity		4	40% to 95%				



3. LNA Gain and Out Band Rejection @3.0V



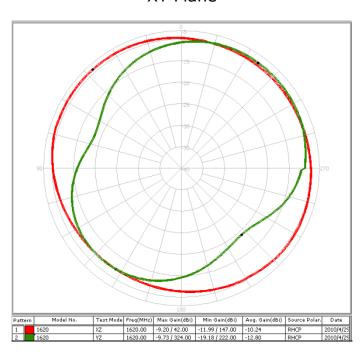
4. LNA Noise Figure @3.0V



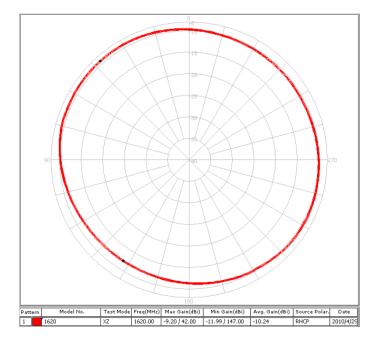


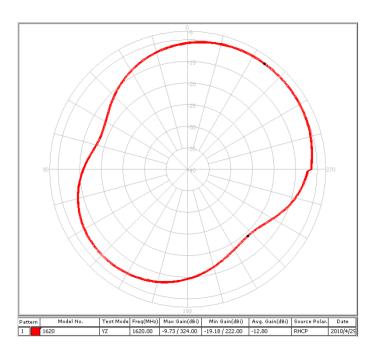
5. Radiation Patterns

XY Plane



XZ Plane YZ Plane

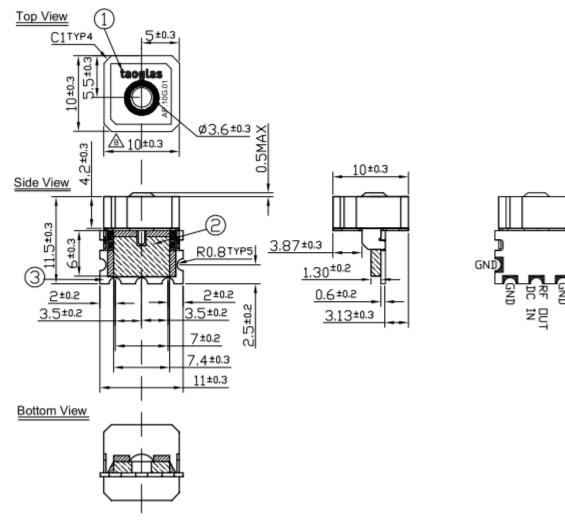






GND

6. Mechanical Drawing (Unit: mm)



	Name	Material	Finish	QTY
1	Patch (10mmx10mmx4.2mm)	Ceramic	Clear	1
2	Shielding Case	Tin (SPTE)	Tin Plated	1
3	PCB	FR4 0.6t	Green	1

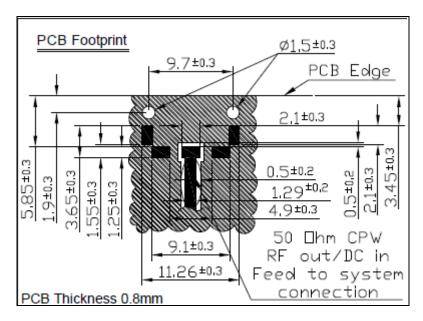
Note:

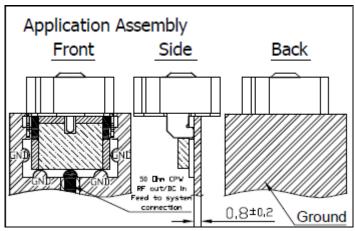
- 1.Soldered Area
- 2.Solder Mask Area(Green)
- 3.Clearance Area
- 4. Shielding Case Area
- 5.Area to be solder (Pad)





6.1. PCB Footprint





Note:

- 1.Soldered Area
- 2.Solder Mask Area(Green)
- 3.Clearance Area
- 4. Shielding Case Area
- 5.Area to be solder (Pad)





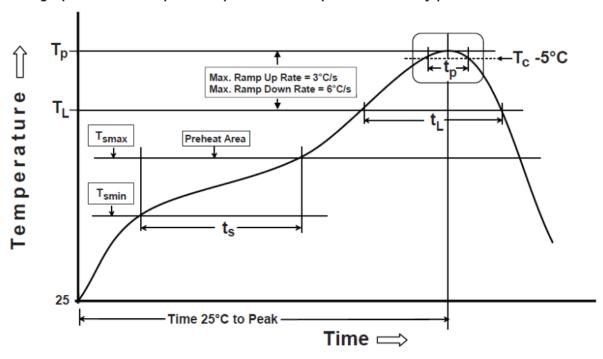
7. Recommended Reflow Soldering Profile

AP.10G can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile Features	(SnAgCu)		
PREHEAT	Temperature Min(Tsmin)	150°C		
	Temperature Max(Tsmax)	200°C		
	Time(ts) from (Tsmin to Tsmax)	60-120 seconds		
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)		
REFLOW	Temperature(TL)	217°C		
	Total Time above TL (tL)	30-100 seconds		
PEAK	Temperature(TP)	260°C		
	Time(tp)	2-5 seconds		
RAMP-DOWN	Rate	3°C/second(max)		
Time from 25°C to Peak Temperature		8 minutes max.		
Composition of solder paste		96.5Sn/3Ag/0.5Cu		
Solder Paste Model		SHENMAO PF606-P26		



The graphic shows temperature profile for component assembly process in reflow ovens



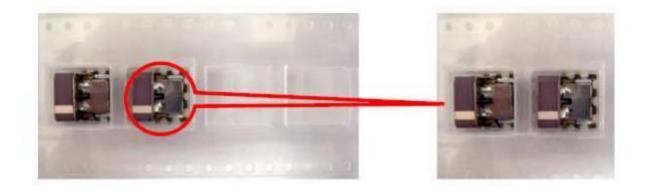
Soldering Iron condition: Soldering iron temperature 270°C±10°C.

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.



8. Packaging

Packaged on Tape and Reel – 250 pieces per reel Each Reel is packaged – Inner Carton Outer Carton contains 5 Reels – 1250 pieces per Carton



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